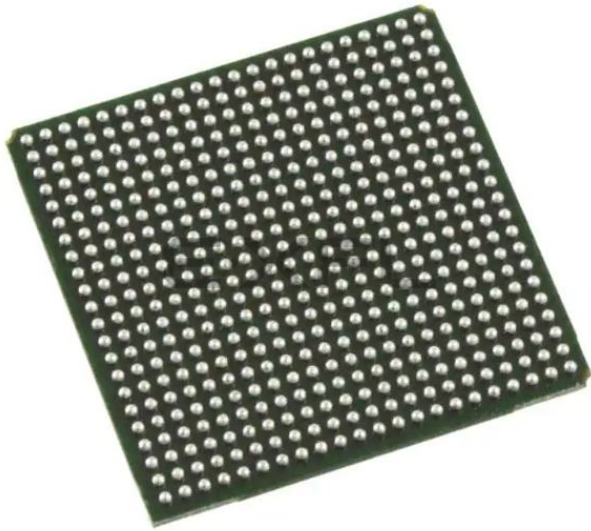




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35e-5fn484c

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

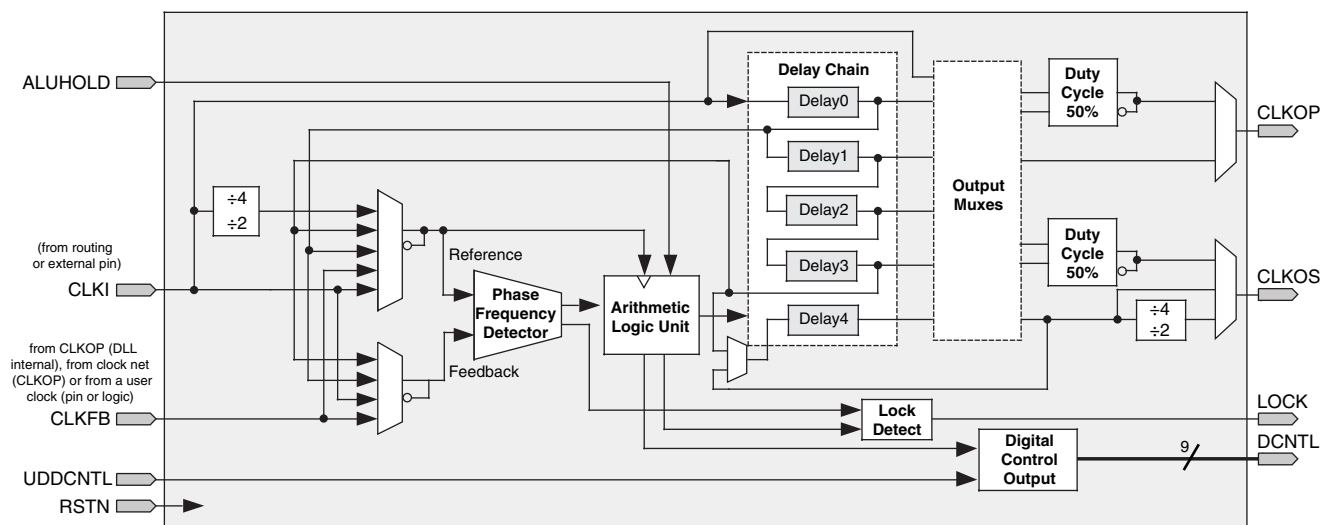
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)

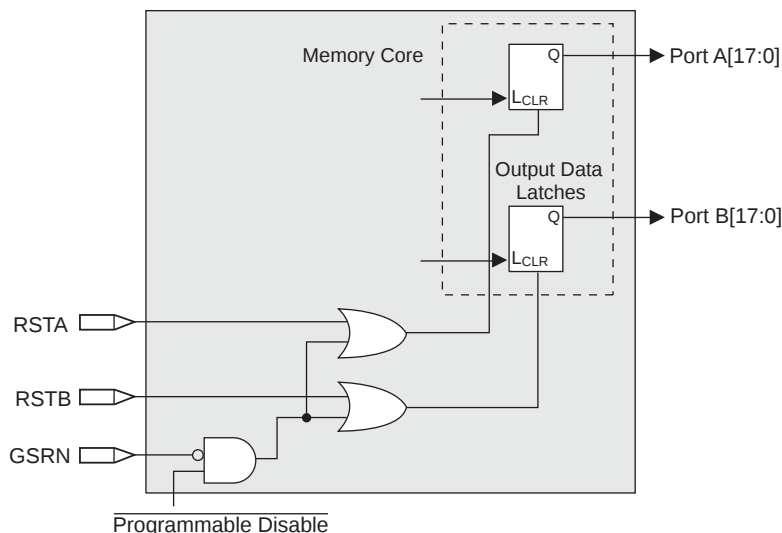


2. Write Through – A copy of the input data appears at the output of the same port during a write cycle. This mode is supported for all data widths.

Memory Core Reset

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously or synchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B, respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-20.

Figure 2-20. Memory Core Reset

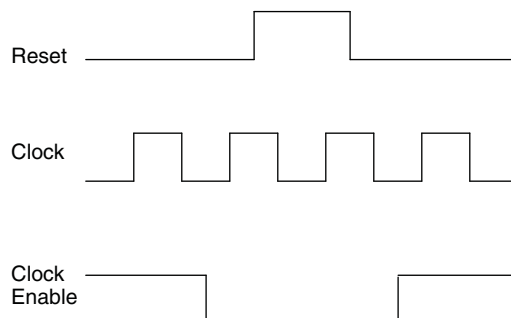


For further information about the sysMEM EBR block, please see the the list of additional technical documentation at the end of this data sheet.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-21. The GSR input to the EBR is always asynchronous.

Figure 2-21. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

Input Standard	V _{REF} (Nom.)	V _{CCIO} ¹ (Nom.)
Single Ended Interfaces		
LVTTL	—	—
LVC MOS33	—	—
LVC MOS25	—	—
LVC MOS18	—	1.8
LVC MOS15	—	1.5
LVC MOS12	—	—
PCI 33	—	3.3
HSTL18 Class I, II	0.9	—
HSTL15 Class I	0.75	—
SSTL3 Class I, II	1.5	—
SSTL2 Class I, II	1.25	—
SSTL18 Class I, II	0.9	—
Differential Interfaces		
Differential SSTL18 Class I, II	—	—
Differential SSTL2 Class I, II	—	—
Differential SSTL3 Class I, II	—	—
Differential HSTL15 Class I	—	—
Differential HSTL18 Class I, II	—	—
LVDS, MLVDS, LVPECL, BLVDS, RSDS	—	—

¹ When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

LatticeECP2M Initialization Supply Current^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ^{5, 6, 7}	Units
I_{CC}	Core Power Supply Current	ECP2M20	41	mA
		ECP2M35	107	mA
		ECP2M50	169	mA
		ECP2M70	254	mA
		ECP2M100	378	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	30	mA
		ECP2M35	30	mA
		ECP2M50	30	mA
		ECP2M70	30	mA
		ECP2M100	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.

2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

4. Frequency 0MHz.

5. $T_J = 25^{\circ}\text{C}$, power supplies at nominal voltage.

6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.

7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

Figure 3-7. DDR and DDR2 Parameters

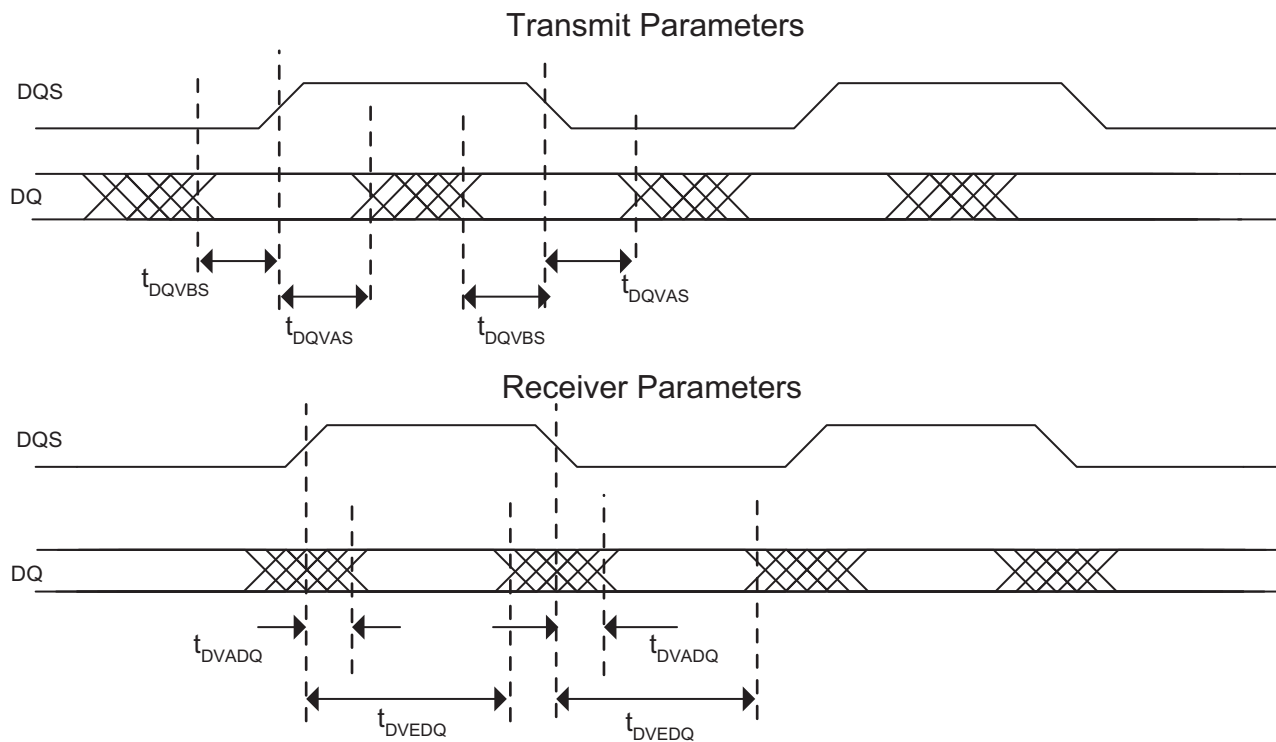
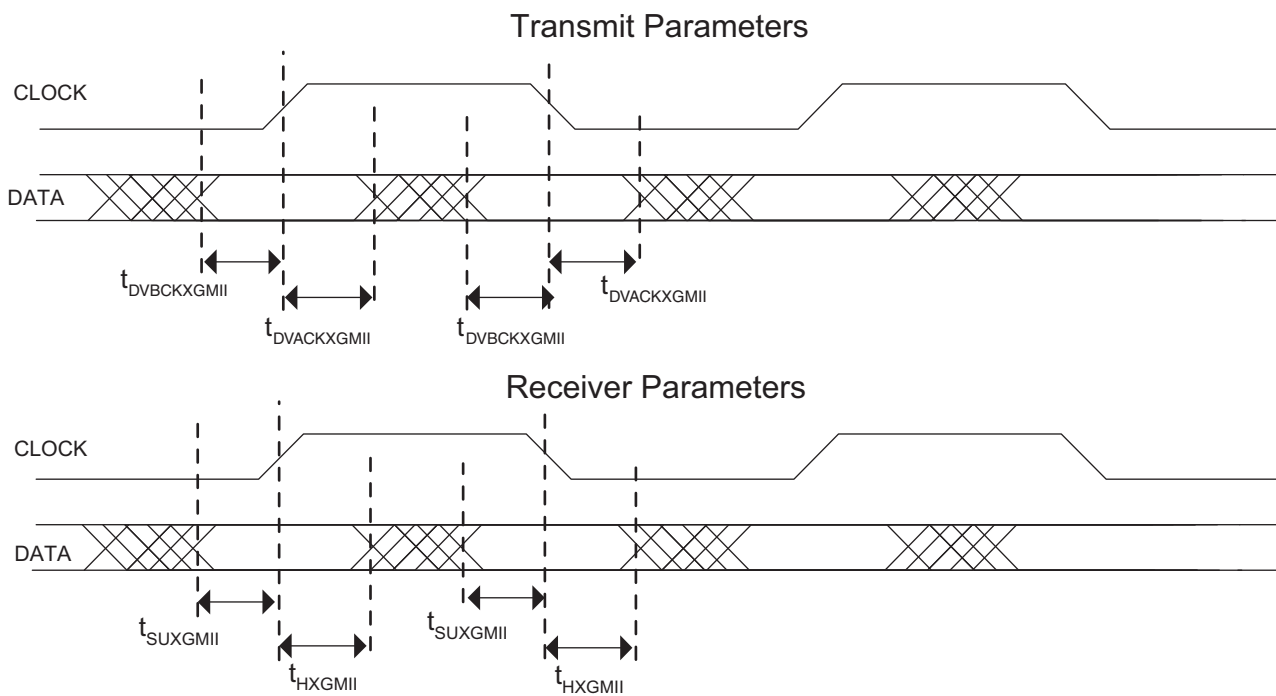


Figure 3-8. XGMII Parameters



DLL Timing

Over Recommended Operating Conditions

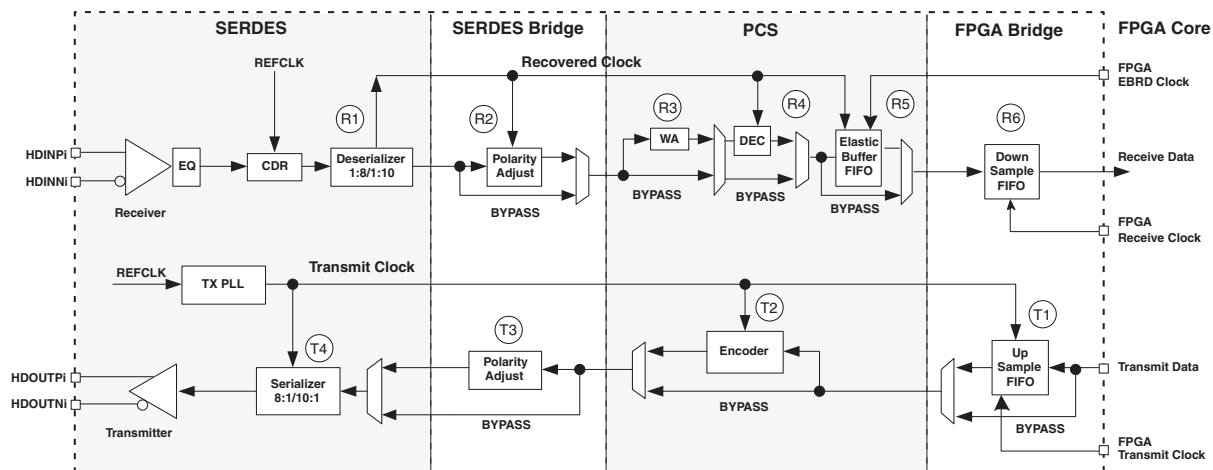
Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

Figure 3-12. Transmitter and Receiver Block Diagram



LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	2	2	2	4	4	4	4
	Bank3	2	1	1	3	4	3	5
	Bank4	3	1	3	3	3	3	3
	Bank5	2	3	3	2	3	2	3
	Bank6	1	2	2	3	4	3	5
	Bank7	3	3	3	4	4	4	5
	Bank8	0	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	0	0	0	0	72	0	80
	Bank3	0	0	0	0	64	0	80
	Bank4	50	24	48	48	40	48	44
	Bank5	60	60	50	40	40	40	46
	Bank6	52	54	60	62	66	62	82
	Bank7	60	60	68	70	74	70	90
	Bank8	0	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2 Power Supply and NC (Cont.)

Signals	672 fpBGA ³	900 fpBGA ³
VCC	LFE2-20: R8, P18, M8, L20, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-35/LFE2-50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-70: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	AA11, AA20, K11, K21, K22, L11, L12, L13, L18, L19, L20, M11, M20, N11, N20, V11, V20, W11, W20, Y10, Y11, Y12, Y13, Y18, Y19, Y20
VCCIO0	D11, D6, G9, J12, K12	J13, J14, K12, K13, K14, K15
VCCIO1	D16, D21, G18, J15, K15	J17, J18, J20, K17, K18, K20
VCCIO2	F23, J20, L23, M17, M18	L21, M21, M22, N21, N22, R21
VCCIO3	AA23, R17, R18, T23, V20	U21, U22, V21, V22, W21, Y22
VCCIO4	AC16, AC21, U15, V15, Y18	AA16, AA17, AA18, AA19, AB17, AB18
VCCIO5	AC11, AC6, U12, V12, Y9	AA12, AA13, AA14, AB12, AB13, AB14
VCCIO6	AA4, R10, R9, T4, V7	U10, U9, V10, W10, W9, Y9
VCCIO7	F4, J7, L4, M10, M9	L10, L9, M10, N10, P10, R10
VCCIO8	AE25, V18	AA21, Y21
VCCJ	AB5	AD3
VCCAUX	J10, J11, J16, J17, K18, L18, T18, U18, V16, V17, V10, V11, T9, U9, K9, L9	AA15, AB11, AB19, AB20, J11, J12, J19, K19, L22, M9, N9, P21, P9, T10, T21, V9, W22
VCCPLL	LFE2-20: None LFE2-35/LFE2-70: R8, P18 LFE2-50: R8, P18, M8, L20	P22, P8, T22, Y7
GND ¹	A2, A25, AA18, AA24, AA3, AA9, AD11, AD16, AD21, AD6, AE1, AE26, AF2, AF25, B1, B26, C11, C16, C21, C6, F18, F24, F3, F9, J13, J14, J21, J6, K10, K11, K13, K14, K16, K17, L10, L11, L16, L17, L24, L3, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T24, T3, U10, U11, U13, U14, U16, U17, V13, V14, V21, V6	A1, A30, AC28, AC3, AH13, AH18, AH23, AH28, AH3, AH8, AK1, AK30, C13, C18, C23, C28, C3, C8, H28, H3, L14, L15, L16, L17, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, N28, N3, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14, U15, U16, U17, U18, U19, U20, V12, V13, V14, V15, V16, V17, V18, V19, V28, V3, W12, W13, W14, W15, W16, W17, W18, W19, Y14, Y15, Y16, Y17
NC ²	LFE2-20: E4, E3, E2, E1, H6, H5, F2, F1, H8, J9, G4, G3, K3, K2, K1, L2, L1, M2, M1, N2, T1, T2, P8, P6, P5, P4, U1, V1, P3, R3, R4, U2, V2, W2, T6, R5, AA19, W17, Y19, Y17, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, R22, T21, P26, P25, R24, R23, P20, R19, P21, P19, P23, P22, N22, R21, N26, N25, J26, J25, J23, K23, H26, H25, H24, H23, F22, E24, D25, C25, D24, B25, H21, G22, B24, C24, D23, C23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-35: K3, K2, K1, L2, L1, M2, M1, N2, M8, P3, R3, R4, U2, V2, W2, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, P26, P25, R24, R23, P20, R19, L20, J26, J25, J23, K23, H26, H25, H24, H23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-50: N6, P24, M3 LFE2-70: M8, L20, M3, P24, N6	A2, A3, A4, A5, AB28, AC4, AD23, AE1, AE2, AE29, AE3, AE30, AE4, AE5, AE6, AF1, AF2, AF23, AF26, AF27, AF28, AF29, AF3, AF30, AF4, AF5, AG1, AG13, AG16, AG18, AG2, AG26, AG27, AG28, AG29, AG3, AG30, AG4, AG8, AH1, AH16, AH2, AH26, AH27, AH29, AH30, AH4, AJ1, AJ2, AJ27, AJ28, AJ29, AJ3, AJ30, AK2, AK27, AK28, AK29, AK3, B1, B2, B3, B30, B4, B5, C1, C2, C29, C30, C4, D13, D18, D23, D28, D29, D3, D30, D4, E25, E26, E27, E28, E29, E3, E30, E4, E5, E6, F25, F5, F6, G6, G7, K10, K9, N27, N4, R1, R2, V27, V4

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.

2. NC pins should not be connected to any active signals, VCC or GND.

3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO6	-			GNDIO6	-		
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C
GND	GNDIO6	-			GNDIO6	-		
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*
N4	TDI	-			TDI	-		
M4	TCK	-			TCK	-		
P3	TDO	-			TDO	-		
N3	TMS	-			TMS	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
K6	NC	-			PB3A	5	BDQ6	
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
R3	NC	-			PB5A	5	BDQ6	T
P4	NC	-			PB5B	5	BDQ6	C
-	-	-			VCCIO	5		
-	-	-			GNDIO5	5		
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB4B	5	BDQ6	C	PB22B	5	BDQ24	C
R6	PB5B	5	BDQ6	C	PB23B	5	BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
R4	PB6A	5	BDQS6	T	PB24A	5	BDQS24	T
L6	PB7A	5	BDQ6	T	PB25A	5	BDQ24	T
T4	PB6B	5	BDQ6	C	PB24B	5	BDQ24	C
L7	PB7B	5	BDQ6	C	PB25B	5	BDQ24	C
N7	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U24	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLL_C_IN_A**/RDQ48	C (LVDS)*	
U25	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLL_T_IN_A**/RDQ48	T (LVDS)*	
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
P18	VCC	3			VCCPLL	3			
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C	
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T	
GND	GNDIO3	-			GNDIO3	-			
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*	
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*	
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C	
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T	
VCCIO	VCCIO3	3			VCCIO3	3			
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*	
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*	
R22	NC	-			PR38B	3	RDQ39	C	
GND	GNDIO3	-			GNDIO3	-			
T21	NC	-			PR38A	3	RDQ39	T	
P26	NC	-			NC	-			
P25	NC	-			NC	-			
R24	NC	-			NC	-			
VCCIO	VCCIO3	3			VCCIO3	3			
R23	NC	-			NC	-			
P20	NC	-			NC	-			
R19	NC	-			NC	-			
P21	NC	-			PR34B	3	RDQ31	C	
GND	GNDIO3	-			GNDIO3	-			
P19	NC	-			PR34A	3	RDQ31	T	
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*	
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*	
N22	NC	-			PR32B	3	RDQ31	C	
VCCIO	VCCIO3	3			VCCIO3	3			
R21	NC	-			PR32A	3	RDQ31	T	
N26	NC	-			PR31B	3	RDQ31	C (LVDS)*	
N25	NC	-			PR31A	3	RDQS31	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
N19	PR24B	3	RDQ25	C	PR30B	3	RDQ31	C	
N20	PR24A	3	RDQ25	T	PR30A	3	RDQ31	T	
M26	PR23B	3	RDQ25	C (LVDS)*	PR29B	3	RDQ31	C (LVDS)*	
M25	PR23A	3	RDQ25	T (LVDS)*	PR29A	3	RDQ31	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
N18	PR22B	3	VREF2_3/RDQ25	C	PR28B	3	VREF2_3/RDQ31	C	
N21	PR22A	3	VREF1_3/RDQ25	T	PR28A	3	VREF1_3/RDQ31	T	
L26	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	
L25	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	
N24	PR19B	2	PCLKC2_0/RDQ16	C	PR25B	2	PCLKC2_0/RDQ22	C	
M23	PR19A	2	PCLKT2_0/RDQ16	T	PR25A	2	PCLKT2_0/RDQ22	T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
G12	PT40B	0		C
E12	PT40A	0		T
VCCIO	VCCIO0	0		
B13	PT39B	0		C
A13	PT39A	0		T
H12	PT38B	0		C
F12	PT38A	0		T
C12	PT37B	0		C
GND	GNDIO0	-		
D12	PT37A	0		T
B12	PT36B	0		C
A12	PT36A	0		T
E11	PT35B	0		C
VCCIO	VCCIO0	0		
G11	PT35A	0		T
F11	PT34B	0		C
H11	PT34A	0		T
C11	PT33B	0		C
D11	PT33A	0		T
B11	PT32B	0		C
GND	GNDIO0	-		
A11	PT32A	0		T
E10	PT31B	0		C
VCCIO	VCCIO0	0		
G10	PT31A	0		T
F10	PT30B	0		C
H10	PT30A	0		T
D10	PT29B	0		C
C10	PT29A	0		T
GND	GNDIO0	-		
VCCIO	VCCIO0	0		
A7	PT16B	0		C
B7	PT16A	0		T
A6	PT15B	0		C
B6	PT15A	0		T
C7	PT14B	0		C
GND	GNDIO0	-		
D7	PT14A	0		T
D8	PT13B	0		C
VCCIO	VCCIO0	0		
E7	PT13A	0		T
C6	PT12B	0		C
D6	PT12A	0		T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y15	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
AA26	NC	-			NC	-		
AB10	PL73B	6	LDQ71	C (LVDS)*	NC	-		
AB11	NC	-			NC	-		
AB12	NC	-			NC	-		
AB13	NC	-			NC	-		
AB14	NC	-			NC	-		
AB15	NC	-			NC	-		
AB16	NC	-			NC	-		
AB17	NC	-			NC	-		
AB19	NC	-			NC	-		
AB20	NC	-			NC	-		
AB21	NC	-			NC	-		
AB9	PL73A	6	LDQ71	T (LVDS)*	NC	-		
AC10	PL74B	6	LDQ71	C	NC	-		
AC11	NC	-			NC	-		
AC21	NC	-			NC	-		
AC22	NC	-			NC	-		
AC8	PL70B	6	LDQ71	C	NC	-		
AC9	PL74A	6	LDQ71	T	NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD4	PL68A	6	LDQ71	T	NC	-		
AD5	PL68B	6	LDQ71	C	NC	-		
AD6	PL71A	6	LDQS71	T (LVDS)*	NC	-		
AD7	PL72A	6	LDQ71	T	NC	-		
AD8	PL72B	6	LDQ71	C	NC	-		
AE23	NC	-			NC	-		
AE5	PL69A	6	LDQ71	T (LVDS)*	NC	-		
AE6	PL70A	6	LDQ71	T	NC	-		
AE7	PL71B	6	LDQ71	C (LVDS)*	NC	-		
AF20	NC	-			NC	-		
AF23	NC	-			NC	-		
AF5	PL69B	6	LDQ71	C (LVDS)*	NC	-		
AG23	NC	-			NC	-		
AG26	NC	-			NC	-		
D10	PT10A	0		T	NC	-		
E10	PT9B	0		C	NC	-		
E11	PT10B	0		C	NC	-		
F10	PT9A	0		T	NC	-		
F20	NC	-			NC	-		
F23	NC	-			NC	-		
F8	PL6B	7	LDQ6	C (LVDS)*	NC	-		
G10	NC	-			NC	-		
G20	NC	-			NC	-		
G21	NC	-			NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AC19	PB96A	4	BDQS96	T
AD20	PB96B	4	BDQ96	C
AB18	PB97A	4	BDQ96	T
AC20	PB97B	4	BDQ96	C
AE20	PB98A	4	BDQ96	T
AE21	PB98B	4	BDQ96	C
VCCIO	VCCIO4	4		
AC23	PB99A	4	BDQ96	T
AD23	PB99B	4	BDQ96	C
GNDIO	GNDIO4	-		
AH18	LRC_SQ_VCCR3	13		
AK19	LRC_SQ_HDINP3	13		T
AJ18	LRC_SQ_VCCIB3	13		
AJ19	LRC_SQ_HDINN3	13		C
AH21	LRC_SQ_VCCTX3	13		
AK22	LRC_SQ_HDOUTP3	13		T
AK21	LRC_SQ_VCCOB3	13		
AJ22	LRC_SQ_HDOUTN3	13		C
AH22	LRC_SQ_VCCTX2	13		
AJ23	LRC_SQ_HDOUTN2	13		C
AH23	LRC_SQ_VCCOB2	13		
AK23	LRC_SQ_HDOUTP2	13		T
AH19	LRC_SQ_VCCR2	13		
AJ20	LRC_SQ_HDINN2	13		C
AH20	LRC_SQ_VCCIB2	13		
AK20	LRC_SQ_HDINP2	13		T
AH24	LRC_SQ_VCCP	13		
AG24	LRC_SQ_REFCLKP	13		T
AF24	LRC_SQ_REFCLKN	13		C
AJ24	LRC_SQ_VCCAUX33	13		
AK28	LRC_SQ_HDINP1	13		T
AH28	LRC_SQ_VCCIB1	13		
AJ28	LRC_SQ_HDINN1	13		C
AH29	LRC_SQ_VCCR1	13		
AK25	LRC_SQ_HDOUTP1	13		T
AH25	LRC_SQ_VCCOB1	13		
AJ25	LRC_SQ_HDOUTN1	13		C
AH26	LRC_SQ_VCCTX1	13		
AJ26	LRC_SQ_HDOUTN0	13		C
AK27	LRC_SQ_VCCOB0	13		
AK26	LRC_SQ_HDOUTP0	13		T
AH27	LRC_SQ_VCCTX0	13		
AJ29	LRC_SQ_HDINN0	13		C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ30	LRC_SQ_VCCIB0	13		
AK29	LRC_SQ_HDINP0	13		T
AH30	LRC_SQ_VCCRX0	13		
AG27	CFG2	8		
AD25	CFG1	8		
AG28	CFG0	8		
AG30	PROGRAMN	8		
AG29	CCLK	8		
AC24	INITN	8		
AF27	DONE	8		
GNDIO	GNDIO8	-		
AF28	WRITEN***	8		
AE26	CS1N***	8		
AB23	CSN***	8		
AF29	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
AF30	D1***	8		
AD26	D2***	8		
AE29	D3***	8		
GNDIO	GNDIO8	-		
AE30	D4***	8		
AD29	D5***	8		
AC25	D6***	8		
AD30	D7/SPID0***	8		
VCCIO	VCCIO8	8		
AA22	DI/CSSPI0N***	8		
AC26	DOUT/CSON/CSSPI1N***	8		
AA23	BUSY/SISPI***	8		
AB22	RLM0_PLLCAP	3		
AC27	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-		
AC28	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AC29	PR101B	3	RLM0_GDLLC_IN_A**/RDQ99	C (LVDS)*
AC30	PR101A	3	RLM0_GDLLT_IN_A**/RDQ99	T (LVDS)*
AB30	PR100B	3	RLM0_GPLLC_IN_A**/RDQ99	C
VCCIO	VCCIO3	3		
AA30	PR100A	3	RLM0_GPLLT_IN_A**/RDQ99	T
AB29	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AB28	PR99A	3	RLM0_GPLLT_FB_A/RDQS99	T (LVDS)*
GNDIO	GNDIO3	-		
Y22	PR98B	3	RDQ99	C
Y23	PR98A	3	RDQ99	T
AB26	PR97B	3	RDQ99	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF27	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
AF28	PR85B	3	RLM0_GDLLC_FB_A	C	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-			GNDIO3	-		
AD26	PR85A	3	RLM0_GDLLT_FB_A	T	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AJ32	PR84B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR101B	3	RLM0_GDLLC_IN_A**/ RDQ99	C (LVDS)*
AJ33	PR84A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR101A	3	RLM0_GDLLT_IN_A**/ RDQ99	T (LVDS)*
AJ34	PR83B	3	RLM0_GPLLC_IN_A**	C	PR100B	3	RLM0_GPLLC_IN_A**/ RDQ99	C
VCCIO	VCCIO3	3			VCCIO3	3		
AK34	PR83A	3	RLM0_GPLLT_IN_A**	T	PR100A	3	RLM0_GPLLT_IN_A**/ RDQ99	T
AH33	PR82B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AH34	PR82A	3	RLM0_GPLLT_FB_A/RDQS82****	T (LVDS)*	PR99A	3	RLM0_GPLLT_FB_A/ RDQS99	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
AF29	PR81B	3	RDQ82	C	PR98B	3	RDQ99	C
AF31	PR81A	3	RDQ82	T	PR98A	3	RDQ99	T
AG33	PR80B	3	RDQ82	C (LVDS)*	PR97B	3	RDQ99	C (LVDS)*
AG34	PR80A	3	RDQ82	T (LVDS)*	PR97A	3	RDQ99	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
AF30	PR79B	3	RDQ82	C	PR96B	3	RDQ99	C
AF32	PR79A	3	RDQ82	T	PR96A	3	RDQ99	T
AE29	PR78B	3	RDQ82	C (LVDS)*	PR95B	3	RDQ99	C (LVDS)*
AE30	PR78A	3	RDQ82	T (LVDS)*	PR95A	3	RDQ99	T (LVDS)*
AF33	NC	-			PR93B	3	RDQ90	C
AF34	NC	-			PR93A	3	RDQ90	T
-	-	-			GNDIO3	-		
AC27	NC	-			PR92B	3	RDQ90	C (LVDS)*
AC28	NC	-			PR92A	3	RDQ90	T (LVDS)*
AD29	NC	-			PR91B	3	RDQ90	C
AD30	NC	-			PR91A	3	RDQ90	T
-	-	-			VCCIO3	3		
AE33	NC	-			PR90B	3	RDQ90	C (LVDS)*
AE34	NC	-			PR90A	3	RDQS90	T (LVDS)*
AD32	NC	-			PR89B	3	RDQ90	C
-	-	-			GNDIO3	-		
AD31	NC	-			PR89A	3	RDQ90	T
AB25	NC	-			PR88B	3	RDQ90	C (LVDS)*
AC25	NC	-			PR88A	3	RDQ90	T (LVDS)*
AB28	NC	-			PR87B	3	RDQ90	C
-	-	-			VCCIO3	3		
AA26	NC	-			PR87A	3	RDQ90	T
AD33	NC	-			PR86B	3	RDQ90	C (LVDS)*
AD34	NC	-			PR86A	3	RDQ90	T (LVDS)*
AC29	PR76B	3	RDQ73	C	PR84B	3	RDQ81	C
GNDIO	GNDIO3	-			GNDIO3	-		
AA27	PR76A	3	RDQ73	T	PR84A	3	RDQ81	T
AC32	PR75B	3	RDQ73	C (LVDS)*	PR83B	3	RDQ81	C (LVDS)*
AC31	PR75A	3	RDQ73	T (LVDS)*	PR83A	3	RDQ81	T (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H33	PR14B	2	RDQ15	C	PR14B	2	RDQ15	C
GNDIO	GNDIO2	-			GNDIO2	-		
H34	PR14A	2	RDQ15	T	PR14A	2	RDQ15	T
J30	PR13B	2	RDQ15	C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
J29	PR13A	2	RDQ15	T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
J27	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
J28	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
H31	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
H32	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
H30	XRES	1			XRES	1		
B33	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
C33	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B34	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
C32	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
B32	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A33	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
C34	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
A32	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
B31	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
A31	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
D32	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A30	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
B30	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
C31	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
D31	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
C30	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
E29	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E30	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D30	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
D29	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
C29	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
D27	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
C28	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
B29	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A29	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
E28	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
A28	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
B28	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
A27	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
D26	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A26	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
B27	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
C27	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B26	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
C26	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
D28	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E4	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F25	NC	-			NC	-		
F26	NC	-			NC	-		
F27	NC	-			NC	-		
F28	NC	-			NC	-		
F29	NC	-			NC	-		
F30	NC	-			NC	-		
F31	NC	-			NC	-		
F32	NC	-			NC	-		
F33	NC	-			NC	-		
F34	NC	-			NC	-		
F5	NC	-			NC	-		
F6	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		
G10	NC	-			NC	-		
G11	NC	-			NC	-		
G24	NC	-			NC	-		
G25	NC	-			NC	-		
G26	NC	-			NC	-		
G27	NC	-			NC	-		
G28	NC	-			NC	-		
G29	NC	-			NC	-		
G30	NC	-			NC	-		
G33	NC	-			NC	-		
G34	NC	-			NC	-		
G7	NC	-			NC	-		
G8	NC	-			NC	-		
G9	NC	-			NC	-		
H10	NC	-			NC	-		
H11	NC	-			NC	-		
H24	NC	-			NC	-		
H25	NC	-			NC	-		
H26	NC	-			NC	-		
H27	NC	-			NC	-		
H28	NC	-			NC	-		
H29	NC	-			NC	-		
H8	NC	-			NC	-		
H9	NC	-			NC	-		
J10	NC	-			NC	-		
J11	NC	-			NC	-		
J24	NC	-			NC	-		
J25	NC	-			NC	-		
J26	NC	-			NC	-		
J9	NC	-			NC	-		
K10	NC	-			NC	-		